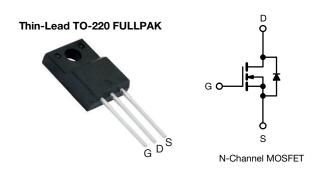
Vishay Siliconix

COMPLIANT HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	850			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 2.38			
Q _g max. (nC)	90			
Q _{gs} (nC)	11			
Q _{gd} (nC)	19			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA2N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	800	V
Gate-source voltage			V_{GS}	± 30	7 v
Continuous drain surrent (T = 150 °C) 8	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I _D	2.8	А
Continuous drain current (T _J = 150 °C) ^a		T _C = 100 °C		1.8	
Pulsed drain current b			I _{DM}	5	
Linear derating factor				0.23	W/°C
Single pulse avalanche energy ^c			E _{AS}	14	mJ
Maximum power dissipation			P _D	29	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope T _J = 125 °C		dv/dt	70	\//	
Reverse diode dv/dt ^d			0.13	V/ns	
Soldering recommendations (peak temperature) e	ering recommendations (peak temperature) e For 10 s			260	°C
Mounting torque, M3 screw				0.6	Nm

Notes

- a. Limited by maximum junction temperature
- b. Repetitive rating; pulse width limited by maximum junction temperature
- c. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 0.9 A
- d. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C
- e. 1.6 mm from case



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R_{thJA}	-	65	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	4.3	C/ VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	1.0	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2.0	-	4.0	V
		,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
		V _{DS} =	800 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.0 A	-	2.38	2.75	Ω
Forward transconductance	9 _{fs}	V _{DS} =	= 30 V, I _D = 1.0 A	-	1.0	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	315	-	pF
Output capacitance	C _{oss}	,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		20	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$			-	13	-	
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	/ to 480 V, V _{GS} = 0 V	-	45	-	
Total gate charge	Qg			-	9.8	19.6	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 1.0 \text{ A}, V_{DS} = 480 \text{ V}$	-	2.4	-	nC
Gate-drain charge	Q _{gd}			-	3.9	-	
Turn-on delay time	t _{d(on)}			-	11	22	
Rise time	t _r	V _{DD} = 480 V, I _D = 1.0 A,		-	7	14	
Turn-off delay time	t _{d(off)}		$= 10 \text{ V, R}_{g} = 9.1 \Omega$	-	19	38	ns
Fall time	t _f			-	27	54	
Gate input resistance	R_g	f = 1 MHz, open drain		1.8	3.6	7.2	Ω
Drain-Source Body Diode Characteristic	s				•		
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	2.8	
Pulsed diode forward current	I _{SM}	integral revers p - n junction		-	-	5	A
Diode forward voltage	V _{SD}	T _J = 25 °	C, I _S = 1 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}	,		-	278	556	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_F = I_S = 1.0 \text{A},$	-	0.9	1.8	μC
Reverse recovery current	I _{RRM}	dl/dt = 100 A/µs, V _R = 25 V		_	5	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

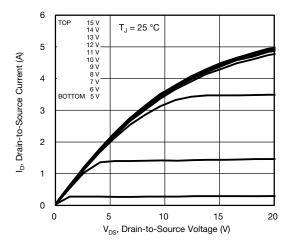


Fig. 1 - Typical Output Characteristics

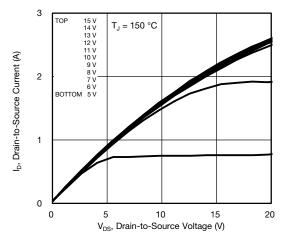


Fig. 2 - Typical Output Characteristics

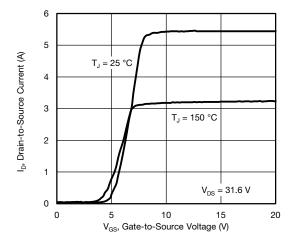


Fig. 3 - Typical Transfer Characteristics

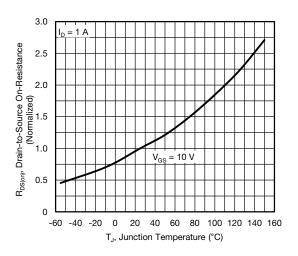


Fig. 4 - Normalized On-Resistance vs. Temperature

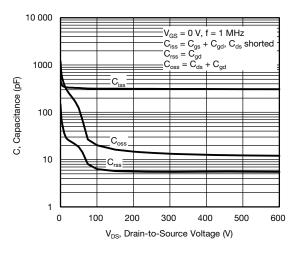


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

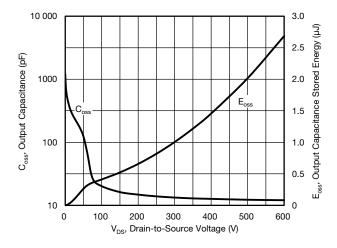


Fig. 6 - Coss and Eoss vs. VDS



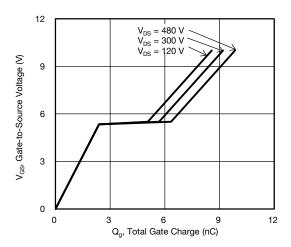


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

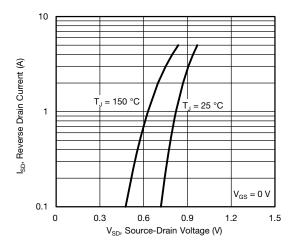


Fig. 8 - Typical Source-Drain Diode Forward Voltage

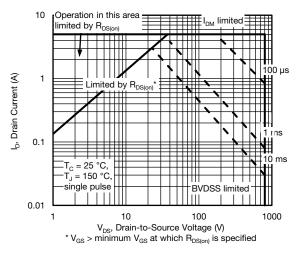


Fig. 9 - Maximum Safe Operating Area

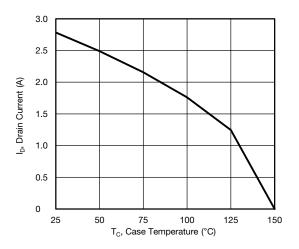


Fig. 10 - Maximum Drain Current vs. Case Temperature

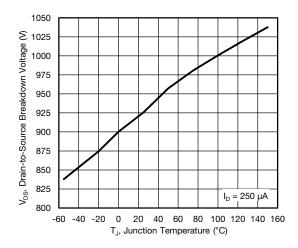


Fig. 11 - Temperature vs. Drain-to-Source Voltage



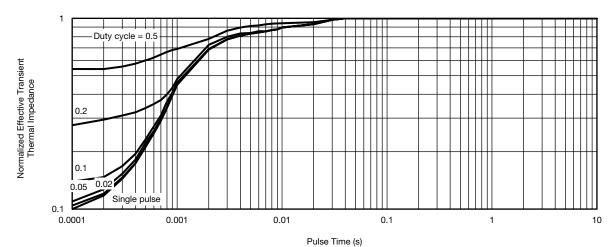
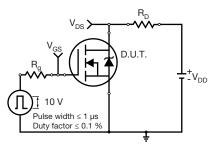


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

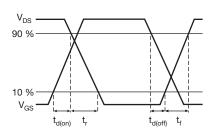


Fig. 14 - Switching Time Waveforms

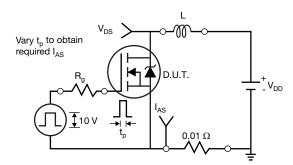


Fig. 15 - Unclamped Inductive Test Circuit

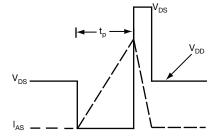


Fig. 16 - Unclamped Inductive Waveforms

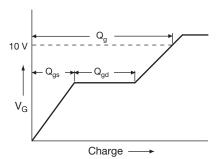


Fig. 17 - Basic Gate Charge Waveform

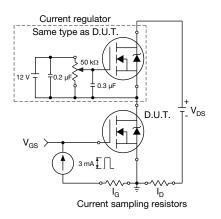
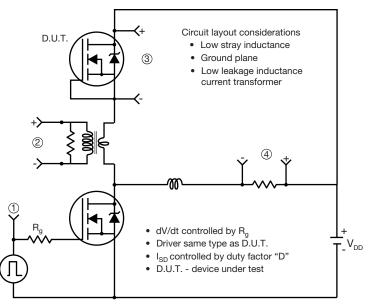


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



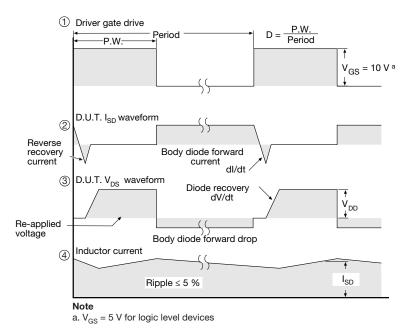


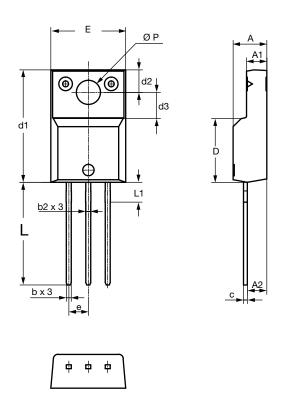
Fig. 19 - For N-Channel

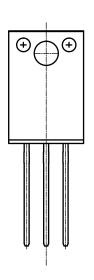
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S18-0587-Rev. B, 18-Jun-2018

Vishay Siliconix

TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIM	METERS	INCI	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
Е	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021

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